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BIBDATASHEET

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CONFIRMATION NO. 5248

SERIAL NUMBE 10/634,074	FILING DATE 08/04/2003 RULE		CLASS 438		GROUP ART UNIT 2824		ATTORNEY DOCKET NO. 2948.7US (96-0555.06/US)			
APPLICANTS										
James M. Wark, Boise, ID;										
** CONTINUING DATA **********************************										
** FOREIGN APPLICATIONS ************************************										
IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 11/05/2003										
Foreign Priority dalmer		yes no Met aff	ter	STATE OR	SH	EETS	то	TAL	INDEPENDENT	
met Verified and Acknowledged	Exa	Allongaboe	Initials	COUNTRY	DR	AWING 5	3	NMS 27	CLAIMS 5	
ADDRESS 24247 TRASK BRITT P.O. BOX 2550 SALT LAKE CITY, UT 84110										
TITLE Methods for stacking wire-bonded integrated circuit dice on flip-chip bonded integrated circuit dice										
	☐ All Fees									
FILING FEE	FILING FEE FEES: Authority has been given in Paper						1.16 Fees (Filing) 1.17 Fees (Processing Ext. of			
No to charge/credit DEPOSIT ACCOUNT RECEIVED No for following:						time)				